INDUSTRY F350

High-performance 3D printer for demanding industrial applications





HIGH PRINT SPEED

up to 400 mm/s

POWERFUL HEATED CHAMBER

Optimum conditions for 3D printing

LARGE BUILD VOLUME

340 x 340 x 350 mm

HIGH-PERFORMANCE MATERIALS

PEEK, CF materials, PC, PA, ABS, soluble supports

The powerful and full-fledged manufacturing system for:

PRODUCTION

FAST | SAFE | RELIABLE | COST-EFFECTIVE

Produce parts cheaper and faster than before with the materials you know. Easily produce end parts or spare parts that can replace worn details.

Durable and accurate end parts manufacturing.

Cost-cutting ensured by high print speed and short downtime.

Batch printing with a large build volume.



PROTOTYPING

VERSATILE | ACCURATE | CONNECTED | SPACIOUS

Accelerate your product development and shorten the road to the market by replacing your traditional prototyping process with 3D printing. The use of a 3D printer in the company allows to significantly reduce the prototyping time.

Head start on the competition with high-performance materials.

Complex prototypes with the use of soluble supports and large build volume.

Controlled environment in a high-temperature chamber.



Flexibility and performance

Job-specific printing modules and developed printing profiles

280

TEMPERATURE:

up to 280°C

NOZZLE DIAMETER:

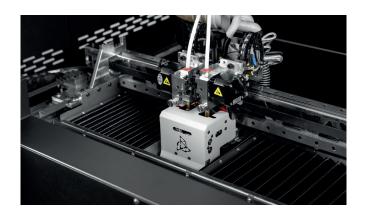
0,5 mm

MODEL MATERIAL:

PLA, ABS, ASA, PA6, PA-CF

SUPPORT MATERIAL:

ESM-10, HIPS



360

TEMPERATURE:

up to 360°C

NOZZLE DIAMETER:

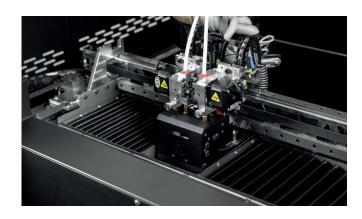
0,4 mm

MODEL MATERIAL:

PC

SUPPORT MATERIAL:

ESM-10



500

TEMPERATURE:

up to 500°C

NOZZLE DIAMETER:

0,4 mm

MODEL MATERIAL:

DEEK

SUPPORT MATERIAL:

ESM-10



SPECIFICATION

Build volume

 $340 \times 340 \times 350 \text{ mm} (40 460 \text{ cm}^3)$

Printing system

Dual extruder equipped with purging station

Filament diameter

1.75 mm

Model materials

PLA, ABS, ASA, PA6, PA-CF, PC, PEEK

Support materials

Breakaway support material, soluble support material ESM-10 – for removing the ESM-10 you need solvent and Support Dissolving System

Material chamber

2 bays (model material and support material)

Nozzle temperature (max.)

500°C

Buildplate temperature (max.)

160°C

Chamber temperature (max.)

140°C (active heating)

Filament chamber temperature (max.)

50°C

Software

3DGence SLICER 4.0, 3DGence CLOUD

Additional accessories

Advanced filtration unit,

UPS - emergency power supply, signal tower

